

#### Description

The HN6971 uses advanced trench technology

to provide excellent  $R_{\text{DS}(\text{ON})},$  low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

#### **General Features**

V<sub>DS</sub> = -60V I<sub>D</sub> =-20 A

 $R_{DS(ON)} < 60m\Omega @ V_{GS} = -10V$ 

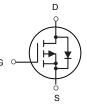
#### Application

Battery protection

Load switch Uninterruptible power supply







P-Channel MOSFET

#### Package Marking and Ordering Information

| Product ID | Pack      | Marking      | Qty(PCS) |
|------------|-----------|--------------|----------|
| HN6971     | DFN3X3-8L | HN6971 XXYYS | 5000     |

### Absolute Maximum Ratings (TC=25°C unless otherwise specified)

| Symbol                                | Parameter   | Rating     | Units |
|---------------------------------------|---|------------|-------|
| VDS                                   | Drain-Source Voltage  | -60        | V     |
| VGS                                   | Gate-Source Voltage   | ±20        | V     |
| I₀@Tc=25℃                             | Continuous Drain Current, V <sub>GS</sub> @ -10V <sup>1</sup> | -20        | A     |
| I <sub>D</sub> @T <sub>C</sub> =100°C | Continuous Drain Current, V <sub>GS</sub> @ -10V <sup>1</sup> | -12        | A     |
| IDM                                   | Pulsed Drain Current <sup>2</sup>                             | -30        | A     |
| EAS                                   | Single Pulse Avalanche Energy <sup>3</sup>                    | 18.1       | mJ    |
| IAS                                   | Avalanche Current   | -13        | A     |
| P₀@Tc=25℃                             | Total Power Dissipation <sup>4</sup>                          | 25         | W     |
| P <sub>D</sub> @T <sub>A</sub> =25℃   | Total Power Dissipation <sup>4</sup>                          | 2          | W     |
| TSTG                                  | Storage Temperature Range                                     | -55 to 150 | °C    |
| TJ                                    | Operating Junction Temperature Range                          | -55 to 150 | °C    |



### Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

| Symbol  | Parameter                                      | Conditions   | Min. | Тур.   | Max. | Unit  |
|---|--|--|------|--------|------|-------|
| BV <sub>DSS</sub>                                       | Drain-Source Breakdown Voltage                 | V <sub>GS</sub> =0V , I <sub>D</sub> =-250uA   | -60  |        |      | V     |
| $\triangle \text{BV}_{\text{DSS}} / \triangle \text{T}$ | BV <sub>DSS</sub> Temperature Coefficient      | Reference to $25^{\circ}C$ , I <sub>D</sub> =-1mA  |      | -0.023 |      | V/°C  |
| D   | Static Drain-Source On-Resistance <sup>2</sup> | V <sub>GS</sub> =-10V , I <sub>D</sub> =-10A   |      | 49     | 60   | ~     |
| R <sub>DS(ON)</sub>                                     | Static Drain-Source On-Resistance              | V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-6A   |      | 61     | 75   | mΩ    |
| V <sub>GS(th)</sub>                                     | Gate Threshold Voltage                         | VGS=VDS . ID =-250uA   | -1.2 |        | -2.5 | V     |
| $	riangle V_{GS(th)}$                                   | V <sub>GS(th)</sub> Temperature Coefficient    | $v_{GS} = v_{DS}$ , $I_D = -2500A$   |      | 4      |      | mV/°C |
| 1   | Droin Source Lookage Current                   | $V_{DS}$ =-24V , $V_{GS}$ =0V , $T_{J}$ =25°C  |      |        | -1   |       |
| IDSS  | Drain-Source Leakage Current                   | $V_{DS}$ =-24V , $V_{GS}$ =0V , $T_J$ =55°C  |      |        | -5   | uA    |
| I <sub>GSS</sub>  | Gate-Source Leakage Current                    | $V_{GS}=\pm 20V$ , $V_{DS}=0V$   |      |        | ±100 | nA    |
| gfs   | Forward Transconductance                       | V <sub>DS</sub> =-5V , I <sub>D</sub> =-15A  |      | 12     |      | S     |
| Qg  | Total Gate Charge (-4.5V)                      |  |      | 6.1    |      |       |
| $Q_{gs}$  | Gate-Source Charge                             | $V_{DS}$ =-15V , $V_{GS}$ =-4.5V , $I_{D}$ =-15A   |      | 3.1    |      | nC    |
| $Q_gd$  | Gate-Drain Charge                              |  |      | 1.8    |      |       |
| T <sub>d(on)</sub>                                      | Turn-On Delay Time                             |  |      | 2.6    |      |       |
| Tr  | Rise Time                                      | $V_{\text{DD}}\text{=-15V}$ , $V_{\text{GS}}\text{=-10V}$ , $R_{\text{G}}\text{=}3.3\Omega,$ |      | 8.6    |      | 20    |
| T <sub>d(off)</sub>                                     | Turn-Off Delay Time                            | I <sub>D</sub> =-15A   |      | 33.6   |      | ns    |
| T <sub>f</sub>  | Fall Time                                      |  |      | 6      |      |       |
| Ciss  | Input Capacitance                              |  |      | 585    |      |       |
| C <sub>oss</sub>  | Output Capacitance                             | V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V , f=1MHz   |      | 100    |      | pF    |
| Crss  | Reverse Transfer Capacitance                   |  |      | 85     |      |       |

#### **Diode Characteristics**

| Symbol          | Parameter                                | Conditions   | Min. | Тур. | Max. | Unit |
|-----------------|--|--|------|------|------|------|
| I <sub>S</sub>  | Continuous Source Current <sup>1,5</sup> |  |      |      | -20  | А    |
| I <sub>SM</sub> | Pulsed Source Current <sup>2,5</sup>     | V <sub>G</sub> =V <sub>D</sub> =0V , Force Current     |      |      | -30  | А    |
| V <sub>SD</sub> | Diode Forward Voltage <sup>2</sup>       | $V_{GS}$ =0V , $I_{S}$ =-1A , $T_{J}$ =25 $^{\circ}$ C |      |      | -1.2 | V    |
| t <sub>rr</sub> | Reverse Recovery Time                    | IF=-15A,dI/dt=100A/µs,                                 |      | 6.1  |      | nS   |
| Q <sub>rr</sub> | Reverse Recovery Charge                  | Tj=25°C  |      | 1.4  |      | nC   |

Note :

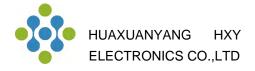
1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%

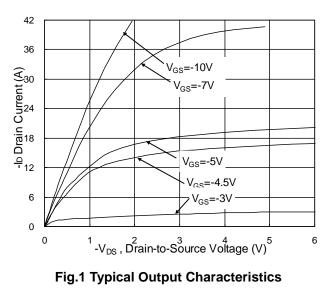
3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =-25V,  $V_{GS}$ =-10V, L=0.1mH,  $I_{AS}$ =-19A

4. The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as  $I_{\text{D}}$  and  $I_{\text{DM}}$  , in real applications , should be limited by total power dissipation.



## **Typical Characteristics**



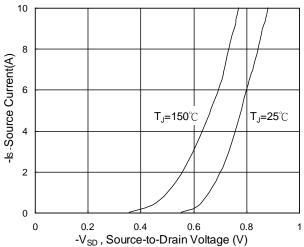


Fig.3 Forward Characteristics Of Reverse

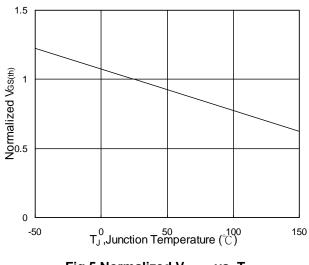


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$ 

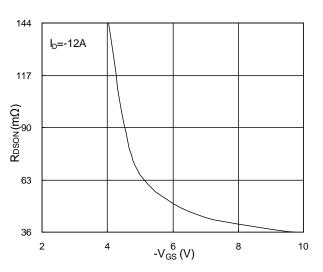


Fig.2 On-Resistance v.s Gate-Source

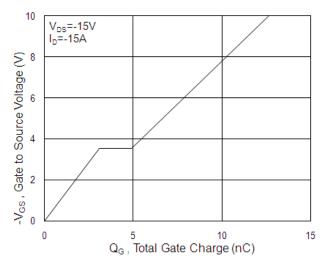


Fig.4 Gate Charge Characteristics

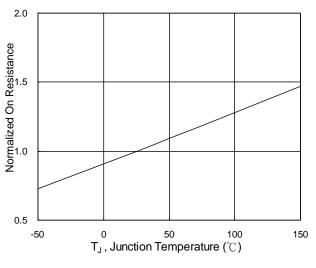
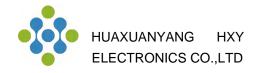
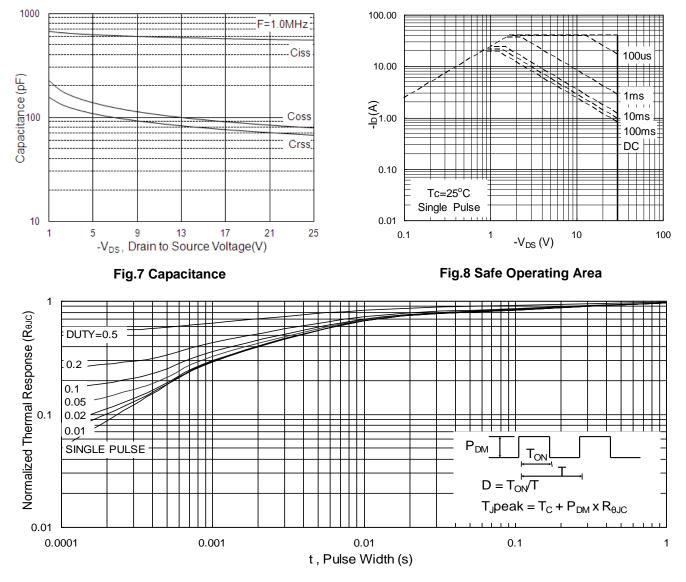
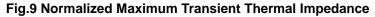


Fig.6 Normalized  $R_{\text{DSON}}$  vs.  $T_{\text{J}}$ 







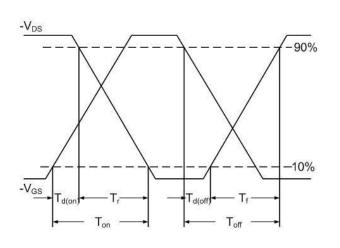


Fig.10 Switching Time Waveform

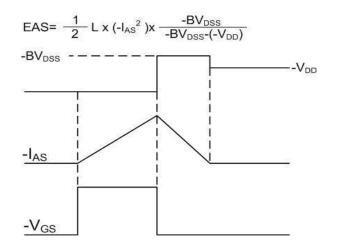
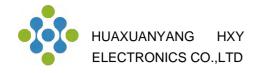
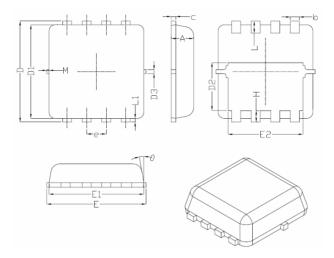


Fig.11 Unclamped Inductive Switching Waveform



# DFN3X3-8L Package Information



| Sumbal | Dimensions In Millimeters |                 |                 |  |  |
|--------|---------------------------|-----------------|-----------------|--|--|
| Symbol | Min.                      | Nom.            | Max.            |  |  |
| A      | 0.70                      | 0.75            | 0.80            |  |  |
| b      | 0.25                      | 0.30            | 0.35            |  |  |
| с      | 0.10                      | 0.15            | 0.25            |  |  |
| D      | 3.25                      | 3.35            | 3.45            |  |  |
| D1     | 3.00                      | 3.10            | 3.20            |  |  |
| D2     | 1.48                      | 1.58            | 1.68            |  |  |
| D3     | -                         | 0.13            | -               |  |  |
| E      | 3.20                      | 3.30            | 3.40            |  |  |
| E1     | 3.00                      | 3.15            | 3.20            |  |  |
| E2     | 2.39                      | 2.49            | 2.59            |  |  |
| e      | 0.65BSC                   |                 |                 |  |  |
| Н      | 0.30                      | 0.39            | 0.50            |  |  |
| L      | 0.30                      | 0.40            | 0.50            |  |  |
| L1     | -                         | 0.13            | -               |  |  |
| М      | *                         | *               | 0.15            |  |  |
| θ      |                           | 10 <sup>°</sup> | 12 <sup>°</sup> |  |  |



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